

Fifth IEEE Dallas Circuits and Systems Workshop

October 29 -- 30 2006 The University of Texas at Dallas



Circuits & Systems: Design, Applications, Integration and Software

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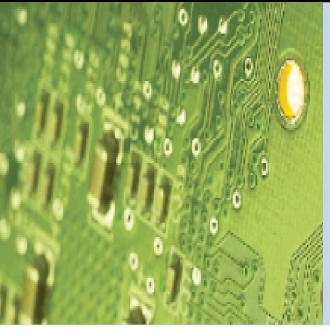
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Andrew Marshall, Texas Instruments

Terry Blake, Texas Instruments

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the handsets and multimedia consumer electronics devices to communication infrastructure, the SoC's create new challenges in design techniques, circuits, integration, power management, packaging and test. The IEEE Dallas Section, Circuit and System Society is conducting a two day workshop (DCAS-06) to provide a forum for sharing Design, Applications, Integration and Software Aspects of Circuits and Systems.

Systems-on-Chip(SoC) with giga-scale

integration of IP are the main drivers of the semiconductor industry today. From

DCAS-06 is sponsored by the IEEE Circuits and Systems Society (Dallas Chapter), and will be held on the campus of The University of Texas at Dallas.

Technical Program

The technical program committee invites researchers from academia and industry to contribute new and previously unpublished results in the following Circuits and Systems related areas:

High Performance & Low Power Circuits Digital Signal Processors and Cores Baseband Communication Processors RF Processors and Circuits Multimedia Processors Reconfigurable Processors Low Voltage and Mixed Signal Circuits Mixed Signal Integration Clocking and Clock Distribution A/D and D/A Conversion High Speed I/O Power Management for SoC Signal Integrity and On-Chip Interconnects SoC Implementation Methodology SoC Verification Methodology SoC and IP Integration

Papers will be accepted for lecture or poster presentation. All accepted papers will be printed in the conference proceedings and online at IEEE Xplore.

Submission Guidelines

Authors are invited to submit a paper draft, not to exceed four pages, to the technical program chair Dr. Bogdan Staszewski (b-staszewski@ti.com). The Submission must include the title, authors names, affiliations, and contact e-mail. Authors are encouraged to follow the instructions posted on the workshop website.

Paper Submission Details

Submission Deadline: August 4, 2006 Acceptance Notice: August 18, 2006 Camera Draft Due: September 1, 2006

http://www.ewh.ieee.org/soc/cas/dallas/wks2006/